

SEPIC evaluation kit

TLD5098EP

About this document

Product description

The TLD5098EP is an AEC qualified DC-DC boost controller, especially designed to drive LEDs.

- Built-in diagnosis and protection features
- Designed to support multiple topologies such as Boost, Buck, Buck-Boost, SEPIC and Flyback

Scope and purpose

Scope of this user manual is to provide instructions on the usage of TLD5098EP SEPIC evaluation board.

Intended audience

This document is intended for engineers who need to perform measurements and check performances with TLD5098EP SEPIC evaluation board.

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1 Description

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Evaluation board for high power LED application with TLD5098EP product in SEPIC topology.

The default configuration of the board is SEPIC topology without any additional features enabled. In this configuration it can deliver up to 21 W to the load with an efficiency above 85%. Auxiliary circuits, which protect the DC-DC and the load during short to ground, are present.

The board is equipped with the following features that are enabled by jumpers:

- Output current adjustment trimmer
- Power derating circuitry
- Cold crank survival circuit (**CCSC**)

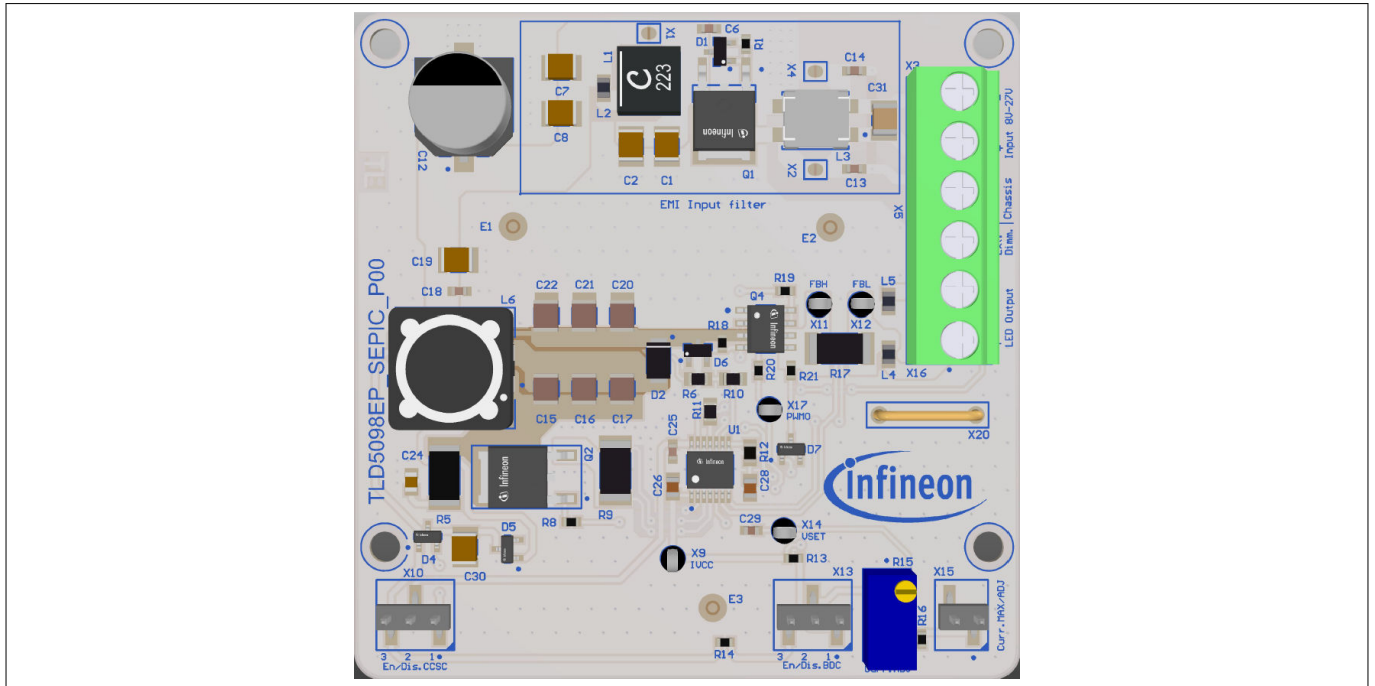


Figure 1 Board picture

1 Description

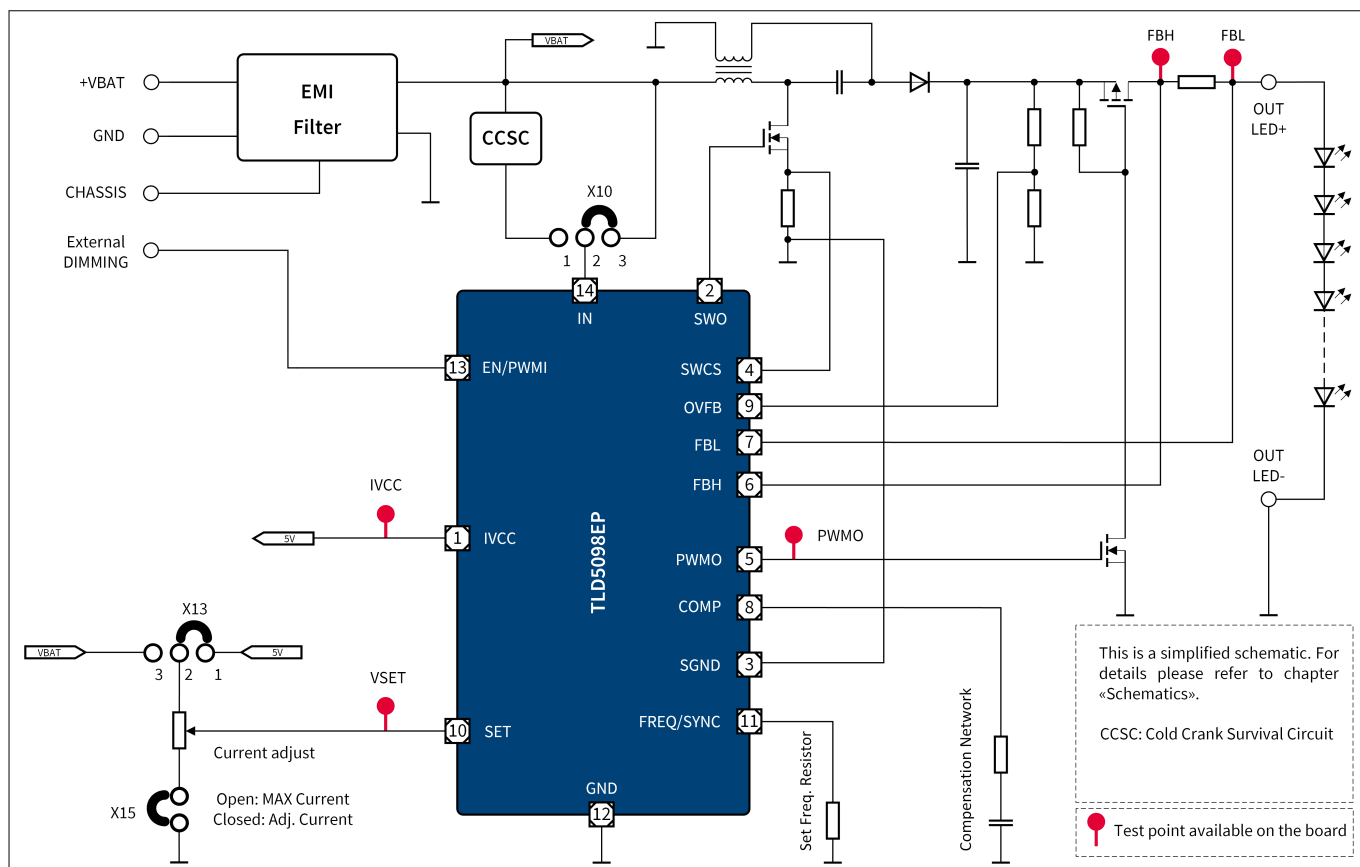


Figure 2 Simplified schematic

Table 1 Performance summary

Parameter	Conditions	Value
Input supply voltage	Jumper X10 in position 2-3 (CCSC deactivated) Parameter degradation below 6.5 V	8 V to 27 V (Down to 6.5 V for less than 2 s)
Input supply voltage	Jumper X10 in position 1-2 (CCSC active)	8 V to 27 V (Down to 3.0 V for less than 2 s)
Output current	Jumper X15 open	1 A
Switching frequency	$V_{IN} = 13.2 \text{ V}$	400 kHz
Efficiency	Measured with 7 white standard LEDs 3 V @ 1 A output current	> 85%
Output voltage range	Output voltage related to positive input	6 V to 23 V
Output overvoltage protection	Output voltage related to ground	28 V

2 Quick start procedure

2 Quick start procedure

The default configuration of the board has all additional features disabled. In this configuration the output current cannot be adjusted. The PWM signal has to be applied as digital signal on X5 (max. 45 V).

Jumpers are populated as follows:

Jumper number	Condition	Meaning
X10	Close 2-3	Disable CCSC
X13	Close 2-1	Disable battery dependent current

The default configuration is depicted below:

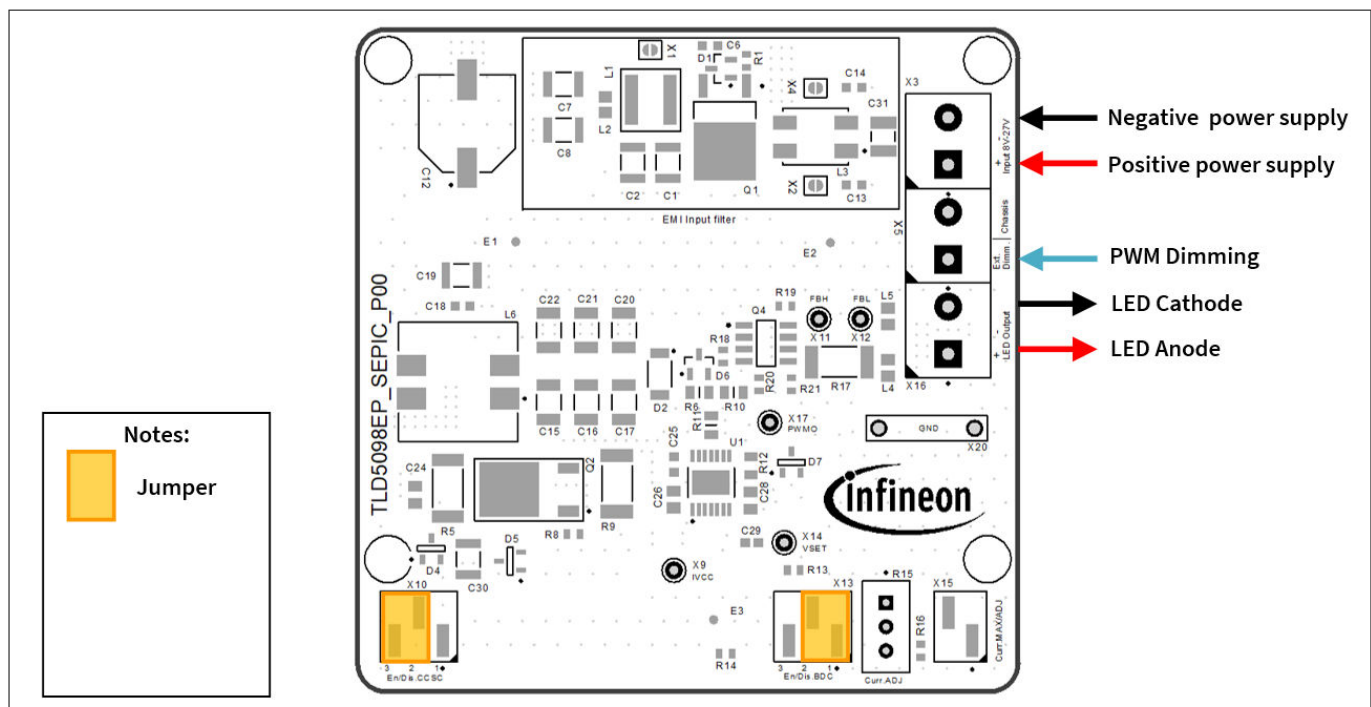


Figure 3 Default configuration of the board

3 Current adjustment

3 Current adjustment

The output current adjustment can be performed by changing the value of trimmer R15 with a screwdriver, when X13 is closed in position 1-2 and X15 is closed. The output current can vary from 0 to 100% of the maximum output current (in this evaluation board from 0 to 1 A). By removing the X15 jumper the output current will reach its maximum value. The PWM signal has to be applied as digital signal on X5 (max. 45 V). Jumpers are populated as follows:

Jumper number	Condition	Meaning
X10	Close 2-3	Disable CCSC
X13	Close 2-1	Disable battery dependent current
X15	Closed	Adjustable output current

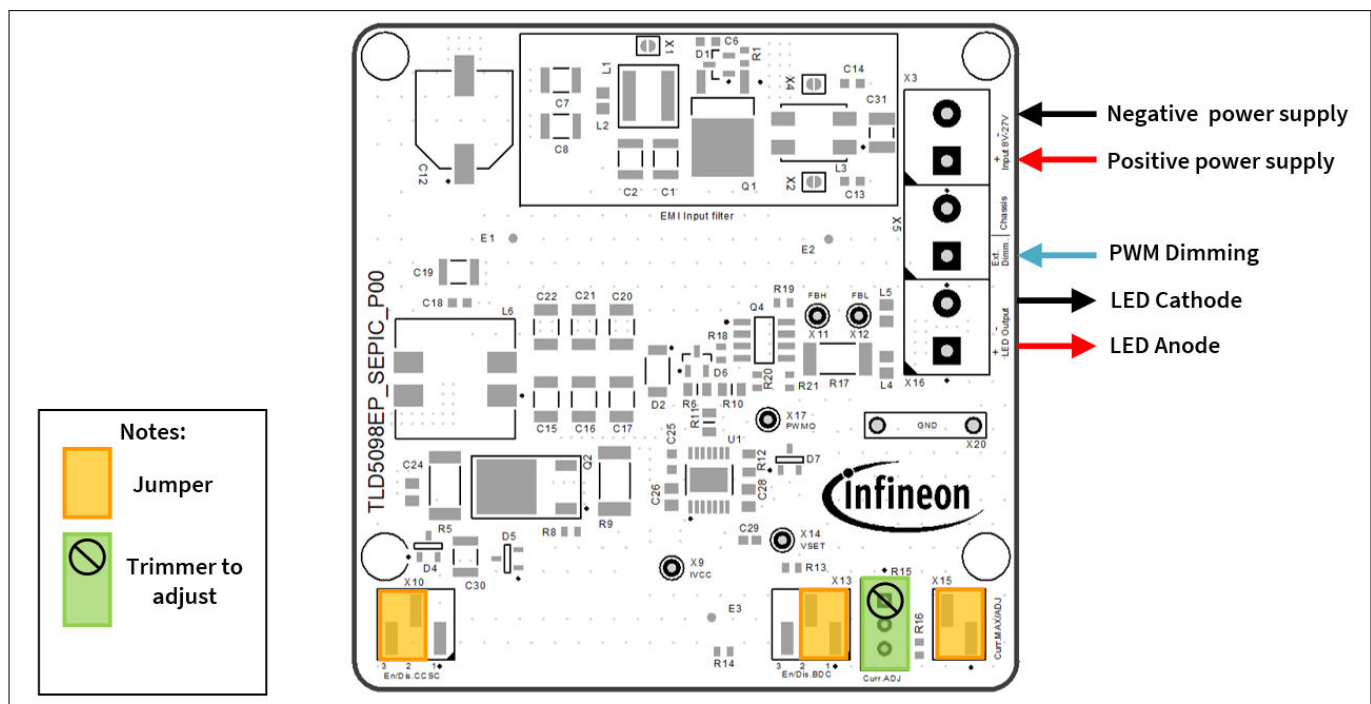


Figure 4 Current adjustment

4 Power derating (battery dependent current)

4 Power derating (battery dependent current)

The power derating acts by reducing V_{SET} (and thus the output current) when the battery voltage drops below 8 V. It works better when R15 is trimmed to its maximum value. Otherwise a different derating profile is applied. If a different derating profile is needed, R14 has to be changed. The aim is to have 1.6 V on pin SET when the battery voltage reaches the desired threshold below which the output current must decrease proportionally. R14 can be calculated using:

(1)

$$R14 = (R15 + R16) \cdot \left(\frac{V_{BATT}}{1.6} - 1 \right)$$

where:

- R15 = 10 kΩ
- R16 = 560 Ω

For example, if the power derating should start when the battery voltage drops under 12 V, R14 must be replaced with a 68 kΩ 0603 resistor (please refer to the TLD5098EP datasheets for more information).

The PWM signal has to be applied as digital signal on X5 (max. 45 V).

Jumpers are populated as follows:

Jumper number	Condition	Meaning
X10	Close 2-3	Disable CCSC
X13	Close 2-3	Enable battery dependent current
X15	Closed	Adjustable output current enabled

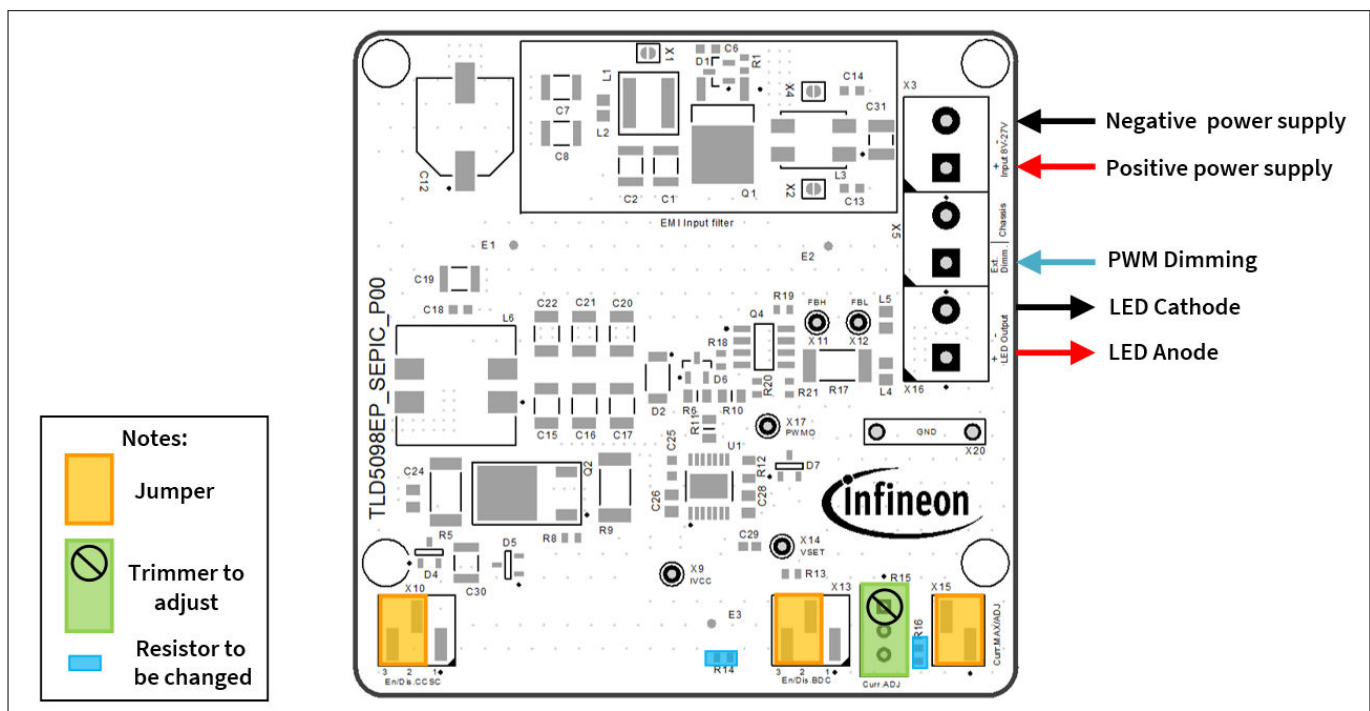


Figure 5 Power derating

5 Cold crank survival circuit

5 Cold crank survival circuit

This feature helps the system to survive LV124 test E11 “severe test pulse”, when the input voltage drops below 4.5 V, which is the minimum input voltage for the TLD5098EP. This circuit feeds back the device with the output voltage when the input voltage drops. To activate this feature, close X10 in position 1-2. Other settings can be left as preferred.

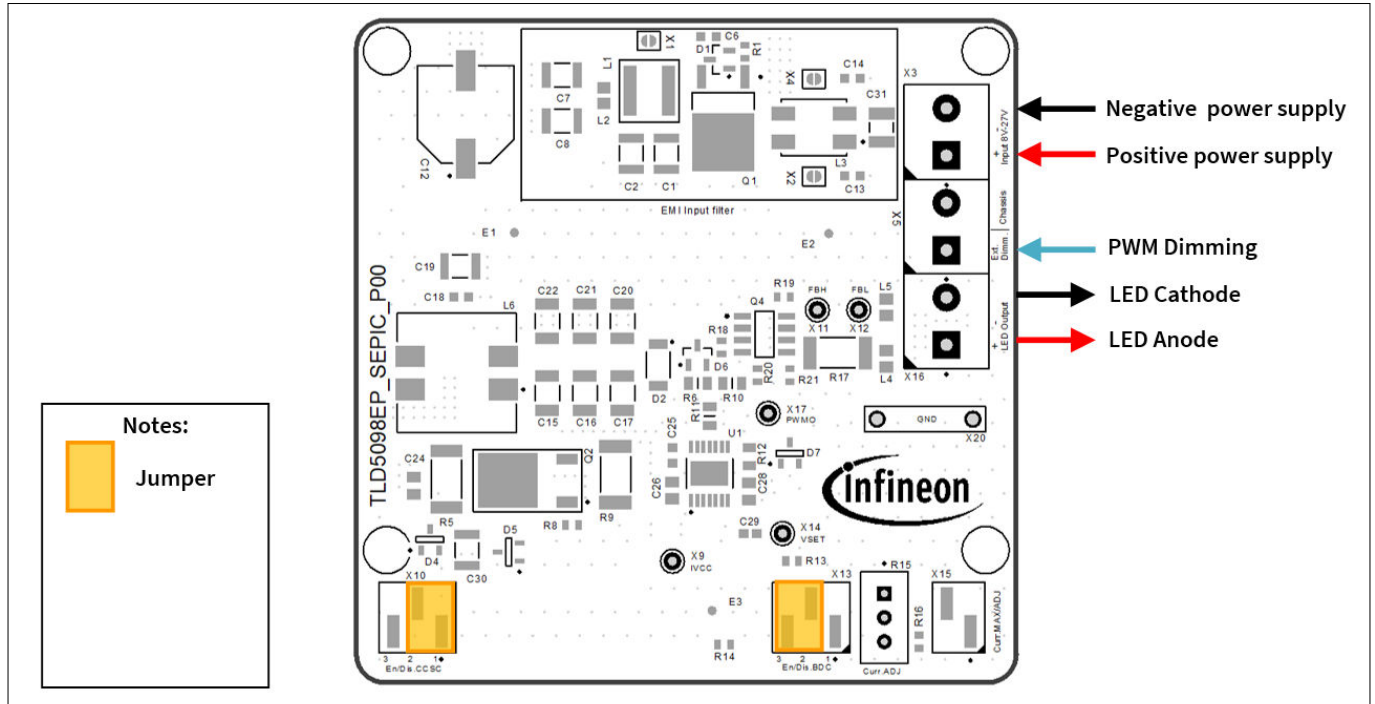


Figure 6 Cold crank survival circuit



6 Schematics

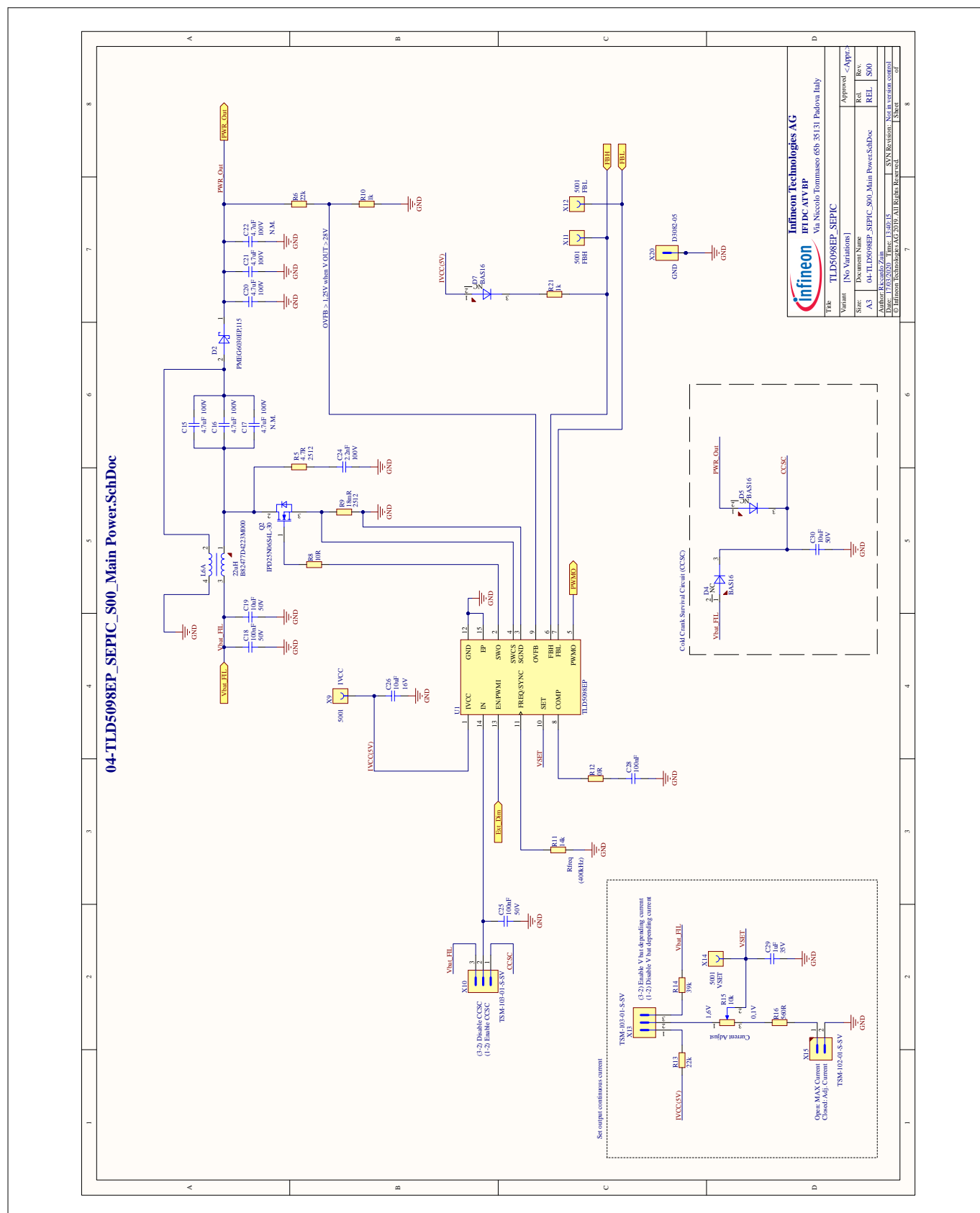


Figure 8 **Main power**

Figure 9 **Output stage**

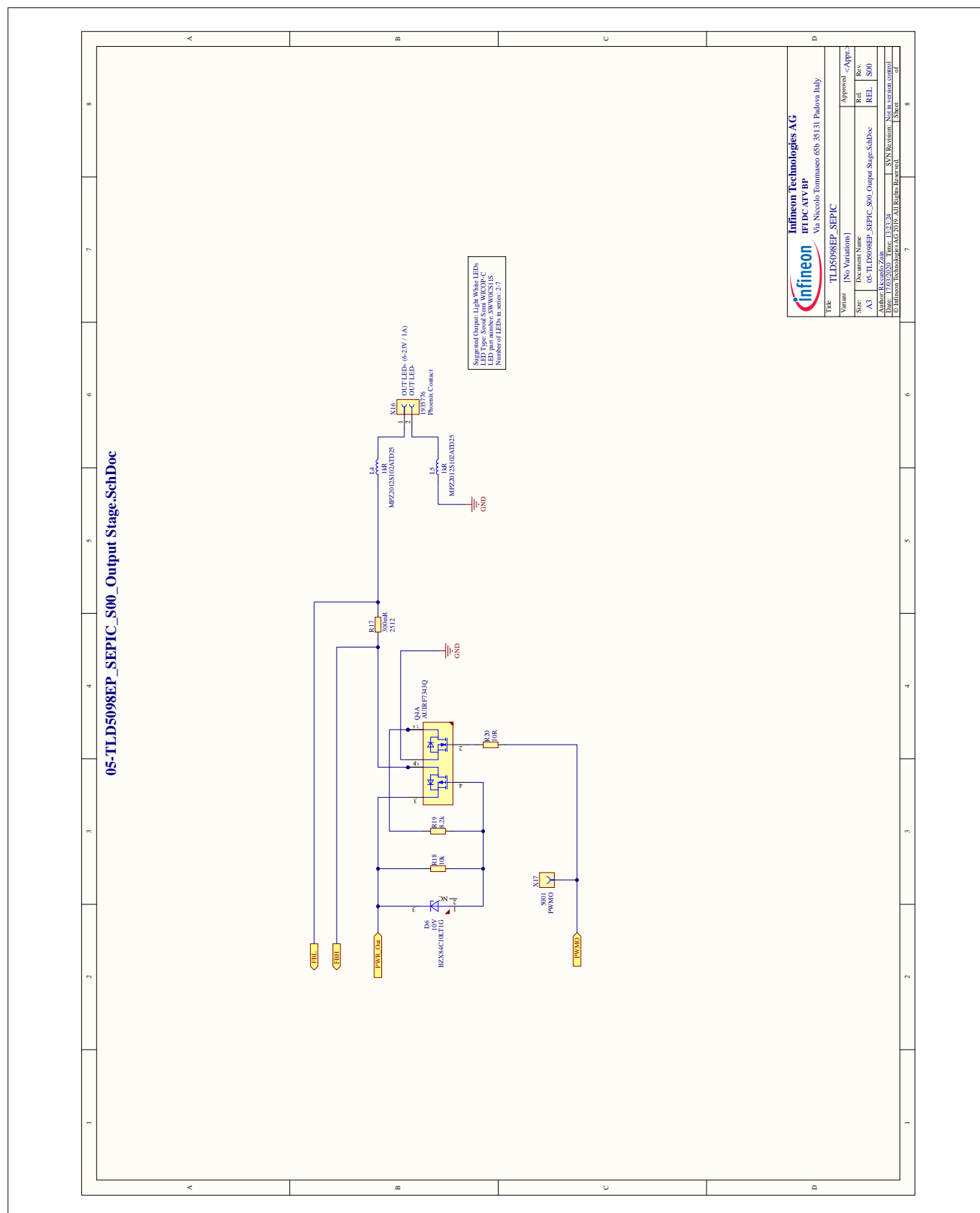


Figure 9 **Output stage**

7 PCB layout

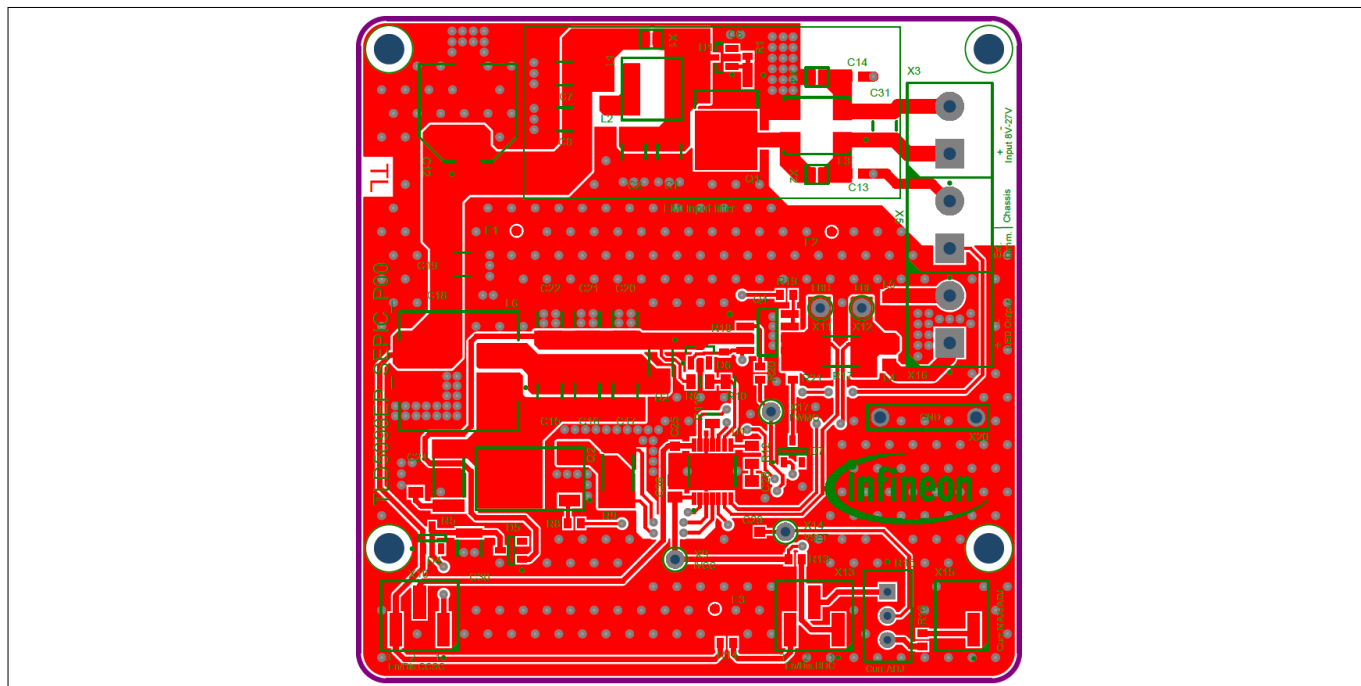


Figure 10 PCB layout top view

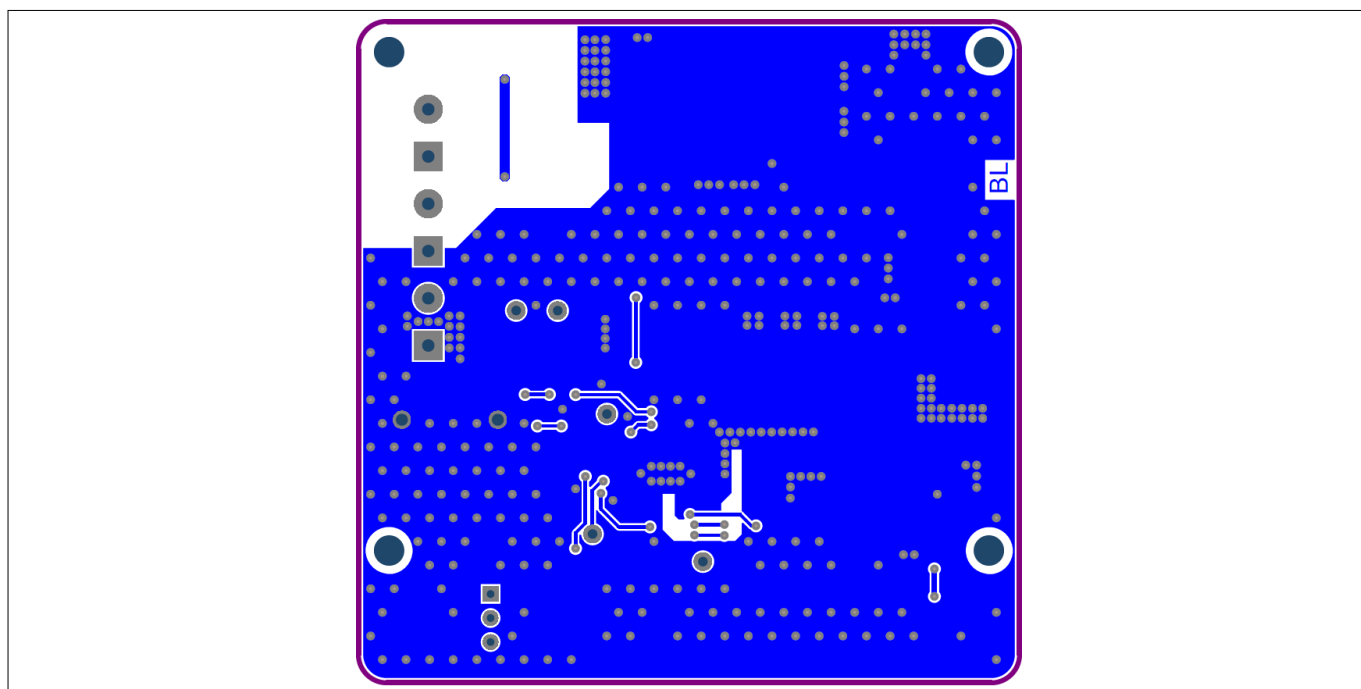


Figure 11 PCB layout bottom view

8 Bill of material

8 Bill of material

Table 2 Bill of material

Designator	Value	Manufacturer	Manufacturer order number
C1, C2, C7, C8, C19, C30	10 uF	Murata	GCM32EC71H106KA03
C6, C18, C25	100 nF	AVX	06035C104K4Z2A
C12	220 uF	Panasonic	EEEFK1H221P
C13, C14	470 pF	Murata	GCM1885C1H471JA16
C15, C16, C20, C21	4.7 uF	TDK	CGA6M3X7S2A475K200AE
C17, C22	4.7 uF	TDK	CGA6M3X7S2A475K200AE
C24	2.2 nF	Murata	GCM2165C2A222FA16
C26	10 uF	TDK	CGA4J1X7S1C106K125AC
C28	100 nF	TDK	CGA4J2X7R2A104M125AE
C29	1 uF	TDK	CGA3E1X7R1V105K080AC
C31	4.7 uF	Kemet	C1210C475K5RACAUTO
D1, D6	10 V	ON Semiconductor	BZX84C10LT1G
D2	PMEG6030EP,115	Nexperia	PMEG6030EP,115
D4, D5, D7	BAS16	Infineon Technologies	BAS16
L1	10 uH	Coilcraft	XAL6060-103MEB
L2	100 Ω @ 100 MHz	TDK	MPZ2012S101ATD25
L3		TDK	ACM70V-701-2PL-TL00
L4, L5	1 k Ω @ 100 MHz	TDK	MPZ2012S102ATD25
L6	22 uH	TDK	B82477D4223M000
Q1	IPD90P04P4L-04	Infineon Technologies	IPD90P04P4L-04
Q2	IPD25N06S4L-30	Infineon Technologies	IPD25N06S4L-30
Q4	AUIRF7343Q	Infineon Technologies	AUIRF7343Q
R1, R18	10 k Ω	Vishay	CRCW060310K0FK
R5	4.7 Ω	Vishay	CRCW25124R70FK
R6	22 k Ω	Vishay	CRCW080522K0FK
R8, R20	10 Ω	Vishay	CRCW060310R0FK
R9	18 m Ω	Vishay	WSL2512R0180FEA18
R10	1 k Ω	Vishay	CRCW08051K00FK
R11	14 k Ω	Vishay	CRCW080514K0FK
R12	0 Ω	Yageo	AC0805JR-070RL
R13	22 k Ω	Vishay	CRCW060322K0FK
R14	39 k Ω	Vishay	CRCW060339K0FK
R15	10 k Ω	Vishay	T93YA103KT20
R16	560 Ω	Vishay	CRCW0603560RFK
R17	300 m Ω	Vishay	WSL2512R3000FEA

8 Bill of material

Table 2 **Bill of material (continued)**

Designator	Value	Manufacturer	Manufacturer order number
R19	8.2 kΩ	Vishay	CRCW06038K20FK
R21	1 kΩ	Vishay	CRCW06031K00FK
U1	TLD5098EP	Infineon Technologies	TLD5098EP
X1, X2, X4	Solder Jumper 2 Pins		
X3, X5, X16	1935776	Phoenix Contact	1935776
X9, X11, X12, X14, X17	5001	Keystone	5001
X10, X13	TSM-103-01-S-SV	Samtec	TSM-103-01-S-SV
X15	TSM-102-01-S-SV	Samtec	TSM-102-01-S-SV
X20	D3082-05	Harwin	D3082-05

9 Efficiency measurements

9 Efficiency measurements

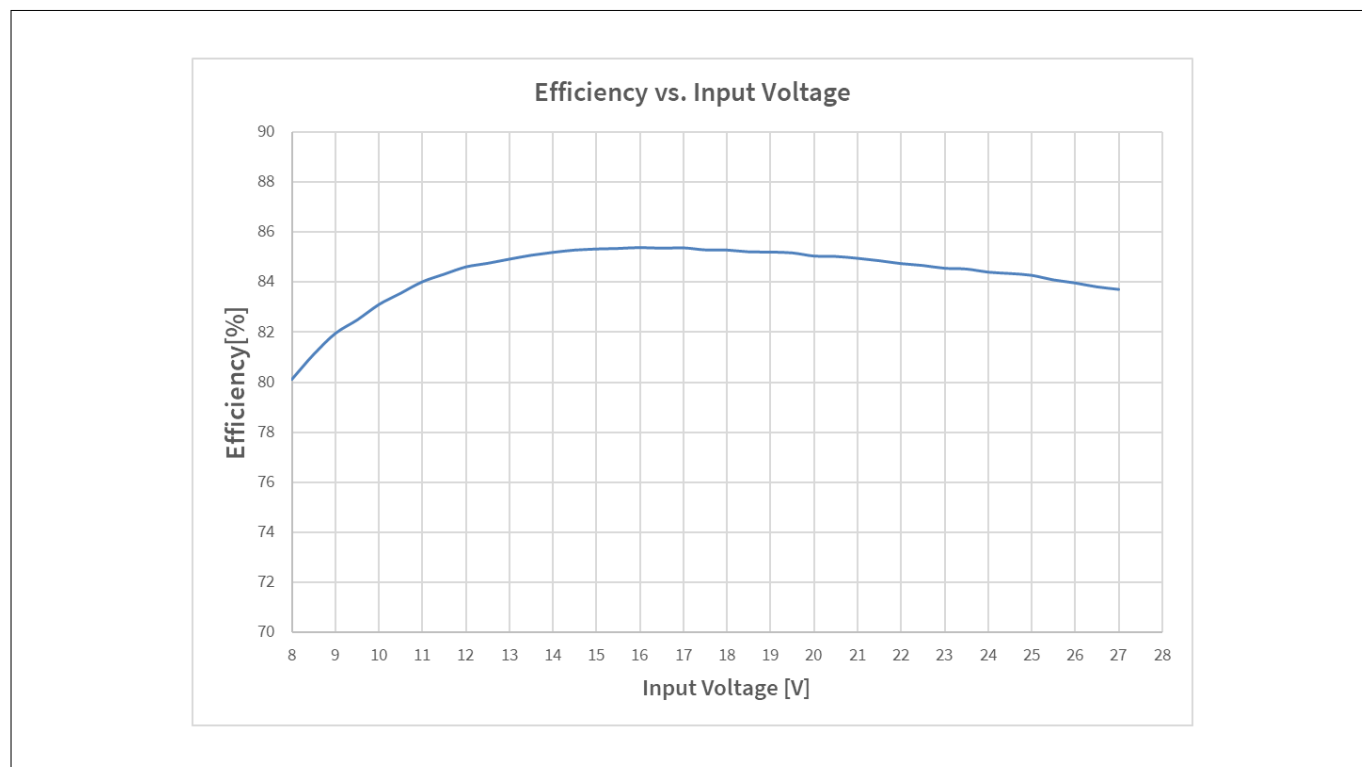


Figure 12 Efficiency vs. input voltage

This efficiency performance has been obtained with:

Table 3 Parameters influencing efficiency

Output load:	Series of 7 white standard LEDs with $V_j \sim 3\text{ V}$ kept cooled with forced air
EMI filter:	Totally bypassed by closing the jumpers X1, X2 and X4
CCSC:	Off (jumper X10 closed on 2-3)
Current adjustment:	Off (jumper X15 left open)
Dimming:	100% D.C.
Power derating:	Off (jumper X13 closed on 1-2)

Efficiency performances can be increased, see [Chapter 11](#).

10 Maximizing efficiency

10 Maximizing efficiency

This evaluation board has been designed to reach a fair compromise between efficiency performance and EM emissions compliance.

Nevertheless, if the maximum efficiency is needed, the following actions should be considered:

- 1.** Remove the snubber circuit consisting of R5 and C24, or choose a lower value for the capacitor C24 (for example 1 nF)
- 2.** Bypass the whole EMI filter by bridging the jumpers X1, X2 and X4
- 3.** Bypass the output ferrite beads L4 and L5
- 4.** Replace the main inductor L6 with one that boasts a lower parasitic DC resistance, for example
 - TDK model B82477C6223M603
 - TDK model B82477D6223M603
- 5.** Turn off the CCSC by placing the jumper X10 on position 2-3
- 6.** Bypass the gate resistor R8

11 Minimizing EM emissions

This evaluation board has been designed to reach a fair compromise between efficiency performance and conducted EM emissions compliance from 150 kHz to 108 MHz.

Nevertheless, if the minimum EM emission is required, the following actions should be considered:

- 1.** Choose a higher value for the capacitor C24 (for example 2.7 or 3.3 nF)
- 2.** Include the whole EMI filter by removing bridges from the jumpers X1, X2 and X4
- 3.** Replace the 10 Ω resistor R8 with a higher value such as 22 Ω
- 4.** Connect the CHASSIS terminal with a short piece of wire as close as possible to the test ground plane where the board is placed

12 Revision history

12 Revision history

Document version	Date of release	Description of change
Rev. 1.00	2020-09-17	First release related to evalboard S00_P00

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